

Darlington Transistors NPN Silicon

2N6426* 2N6427

*ON Semiconductor Preferred Device

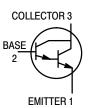
MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector–Emitter Voltage	VCEO	40	Vdc	
Collector–Base Voltage	VCBO	40	Vdc	
Emitter-Base Voltage	VEBO	12	Vdc mAdc	
Collector Current — Continuous	IC	500		
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	625 5.0	mW mW/°C	
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	1.5 12	Watts mW/°C	
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C	



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector–Emitter Breakdown Voltage (1) (IC = 10 mAdc, VBE = 0)	V(BR)CEO	40	_	_	Vdc	
Collector–Base Breakdown Voltage (I _C = 100 μAdc, I _E = 0)	V(BR)CBO	40	_	_	Vdc	
Emitter–Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V(BR)EBO	12	_	_	Vdc	
Collector Cutoff Current (VCE = 25 Vdc, IB = 0)	ICES	_	_	1.0	μAdc	
Collector Cutoff Current (V _{CB} = 30 Vdc, I _E = 0)	ICBO	_	_	50	nAdc	
Emitter Cutoff Current (V _{EB} = 10 Vdc, I _C = 0)	IEBO	_	_	50	nAdc	

^{1.} Pulse Test: Pulse Width \leq 300 $\mu s;$ Duty Cycle \leq 2.0%.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

Characteristic		Symbol	Min	Тур	Max	Unit
ON CHARACTERISTICS						
DC Current Gain ⁽¹⁾ (I _C = 10 mAdc, V _{CE} = 5.0 Vdc)	2N6426 2N6427	hFE	20,000 10,000	_	200,000	_
$(I_C = 100 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc})$	2N6426 2N6427		30,000 20,000	_	300,000 200,000	
$(I_C = 500 \text{ mAdc}, V_{CE} = 5.0 \text{ Vdc})$	2N6426 2N6427		20,000 14,000	_	200,000 140,000	
Collector–Emitter Saturation Voltage (I _C = 50 mAdc, I _B = 0.5 mAdc) (I _C = 500 mAdc, I _B = 0.5 mAdc		VCE(sat)	_	0.71 0.9	1.2 1.5	Vdc
Base–Emitter Saturation Voltage (I _C = 500 mAdc, I _B = 0.5 mAdc)		VBE(sat)	_	1.52	2.0	Vdc
Base–Emitter On Voltage (IC = 50 mAdc, VCE = 5.0 Vdc)		VBE(on)	_	1.24	1.75	Vdc
SMALL-SIGNAL CHARACTERISTICS						
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 1.0 MHz)		C _{obo}	_	5.4	7.0	pF
Input Capacitance (V _{EB} = 1.0 Vdc, I _C = 0, f = 1.0 MHz)		C _{ibo}	_	10	15	pF
Input Impedance (IC = 10 mAdc, VCE = 5.0 Vdc, f = 1.0 kHz)	2N6426 2N6427	h _{ie}	100 50	_	2000 1000	kΩ
Small–Signal Current Gain (IC = 10 mAdc, VCE = 5.0 Vdc, f = 1.0 kHz)	2N6426 2N6427	h _{fe}	20,000 10,000	_	_	_
Current–Gain — High Frequency (I _C = 10 mAdc, V _{CE} = 5.0 Vdc, f = 100 MHz)	2N6426 2N6427	h _{fe}	1.5 1.3	2.4 2.4		_
Output Admittance (I _C = 10 mAdc, V _{CE} = 5.0 Vdc, f = 1.0 kHz)		h _{oe}	_	_	1000	μmhos
Noise Figure (IC = 1.0 mAdc, V_{CE} = 5.0 Vdc, R_S = 100 k Ω , f = 1.0 kHz)	NF	_	3.0	10	dB

^{1.} Pulse Test: Pulse Width \leq 300 μ s; Duty Cycle \leq 2.0%.

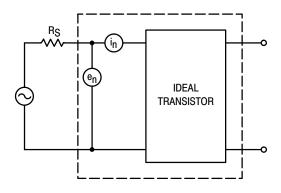


Figure 1. Transistor Noise Model

NOISE CHARACTERISTICS

 $(VCE = 5.0 \text{ Vdc}, T_A = 25^{\circ}C)$

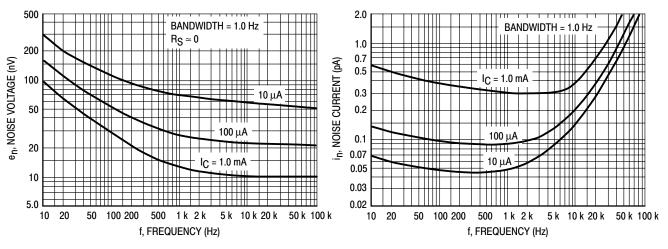


Figure 2. Noise Voltage

Figure 3. Noise Current

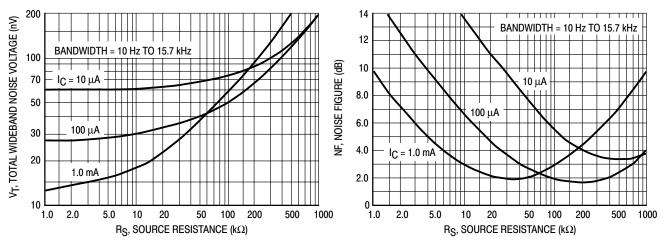


Figure 4. Total Wideband Noise Voltage

Figure 5. Wideband Noise Figure

SMALL-SIGNALCHARACTERISTICS

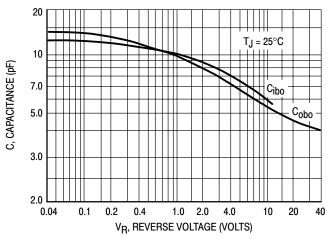


Figure 6. Capacitance

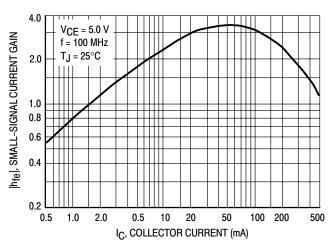


Figure 7. High Frequency Current Gain

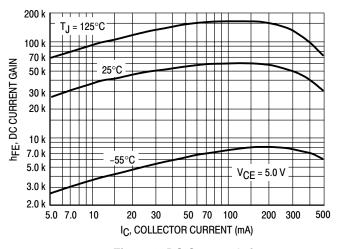


Figure 8. DC Current Gain

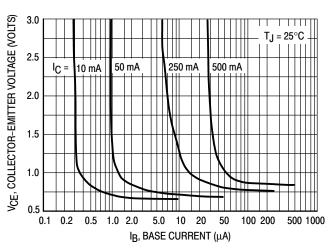


Figure 9. Collector Saturation Region

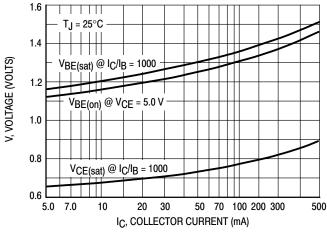


Figure 10. "On" Voltages

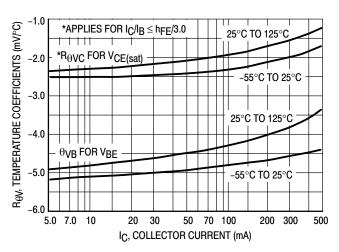


Figure 11. Temperature Coefficients

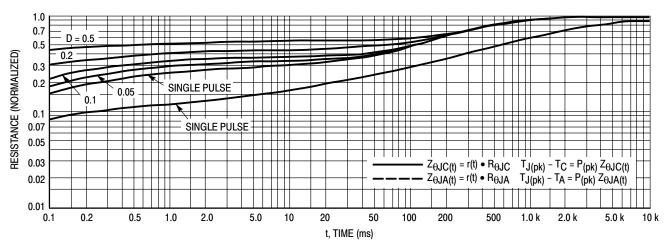


Figure 12. Thermal Response

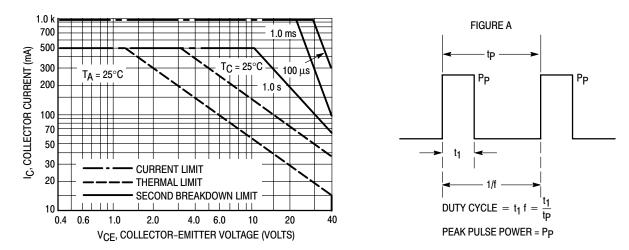
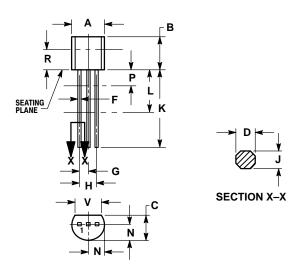


Figure 13. Active Region Safe Operating Area Design Note: Use of Transient Thermal Resistance Data

PACKAGE DIMENSIONS

CASE 029-04 (TO-226AA) ISSUE AD



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IMETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.175	0.205	4.45	5.20	
В	0.170	0.210	4.32	5.33	
C	0.125	0.165	3.18	4.19	
D	0.016	0.022	0.41	0.55	
F	0.016	0.019	0.41	0.48	
G	0.045	0.055	1.15	1.39	
Н	0.095	0.105	2.42	2.66	
J	0.015	0.020	0.39	0.50	
K	0.500		12.70		
L	0.250		6.35		
N	0.080	0.105	2.04	2.66	
P		0.100		2.54	
R	0.115		2.93		
٧	0.135		3.43		

STYLE 1:
PIN 1. EMITTER
2. BASE
3. COLLECTOR

Notes

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

Literature Fulfillment:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA

Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada **Fax:** 303–675–2176 or 800–344–3867 Toll Free USA/Canada

Email: ONlit@hibbertco.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

JAPAN: ON Semiconductor, Japan Customer Focus Center 4–32–1 Nishi–Gotanda, Shinagawa–ku, Tokyo, Japan 141–0031

Phone: 81–3–5740–2700 **Email**: r14525@onsemi.com

ON Semiconductor Website: http://onsemi.com

For additional information, please contact your local

Sales Representative.

Copyright © Each Manufacturing Company.

All Datasheets cannot be modified without permission.

This datasheet has been download from:

www.AllDataSheet.com

100% Free DataSheet Search Site.

Free Download.

No Register.

Fast Search System.

www.AllDataSheet.com